

UNITED STATES PATENT AND TRADEMARK OFFICE GRANTED
PATENT

6330755

December 18, 2001

Vacuum processing and operating method

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FILED-DATE: December 16, 1999

GRANTED-DATE: December 18, 2001

PRIORITY: August 29, 1990 - 2-225321, Japan (JP)

ENGLISH-ABST:

This invention relates to a vacuum processing apparatus having vacuum processing chambers the insides of which must be dry cleaned, and to a method of operating such an apparatus. When the vacuum processing chambers are dry-cleaned, dummy substrates are transferred into the vacuum processing chamber by substrates conveyor means from dummy substrate storage means which is disposed in the air atmosphere together with storage means for storing substrates to be processed, and the inside of the vacuum processing chamber is dry-cleaned by generating a plasma. The dummy substrate is returned to the dummy substrate storage means after dry cleaning is completed. Accordingly, any specific mechanism for only the cleaning purpose is not necessary and the construction of the apparatus can be made simple. Furthermore, the dummy substrates used for dry cleaning and the substrates to be processed do not coexist, contamination of the substrates to be processed due to dust and remaining gas can be prevented and the production yield can be high.

Selected file: PLUSPAT

**** SS 1: Results 1**

1 / 1 PLUSPAT - @QUESTEL-ORBIT
PN - US6330755 B1 20011218 [US6330755]
TI - (B1) Vacuum processing and operating method
PA - (B1) HITACHI LTD (US)
PAO - Hitachi, Ltd., Tokyo [JP]
IN - (B1) TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP); KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP)
AP - US46143299 19991216 [1999US-0461432]
FD - Cont. of US177495 19981023 [1998US-0177495]
Cont. of US061062 19980416 [1998US-0061062]
Cont. of US882731 19970626 [1997US-0882731]
Divsn of US593870 19960130 [1996US-0593870]
Cont. of US443039 19950517 [1995US-0443039]
Divsn of US302443 19940909 [1994US-0302443]
Cont. of US096256 19930726 [1993US-0096256]
Cont. of US751951 19910829 [1991US-0751951]
Continuation of: US6012235
Continuation of: US5950330
Continuation of: US5784799
Division of: US5661913
Continuation of: US5553396
Division of: US5457896
Continuation of: US5349762
Continuation of: US5314509
PR - US46143299 19991216 [1999US-0461432]
JP22532190 19900829 [1990JP-0225321]
US17749598 19981023 [1998US-0177495]
US6106298 19980416 [1998US-0061062]
US88273197 19970626 [1997US-0882731]
US59387096 19960130 [1996US-0593870]
US44303995 19950517 [1995US-0443039]
US30244394 19940909 [1994US-0302443]
US9625693 19930726 [1993US-0096256]
US75195191 19910829 [1991US-0751951]
IC - (B1) F26B-005/04
EC - C23C-014/56D
H01L-021/00S2D4
H01L-021/00S2Z
H01L-021/00S6
H01L-021/00S6B
H01L-021/00S8B
PCL - ORIGINAL (O) : 034406000
DT - Corresponding document
CT - US3652444; US3981791; US4138306; US4226897; US4311427; US4313783;
US4313815; US4318767; US4449885; US4457661; US4534314; US4563240;
US4576698; US4634331; US4643629; US4705951; US4715764; US4824309;
US4836733; US4836905; US4851101; US4895107; US4902934; US4903937;
US4909695; US4911597; US4915564; US4917556; US4923584; US4924890;
US4936329; US4951601; US4969790; US5007981; US5014217; US5225036;
US5292393; US5351415; US5436848; US5452166; US5462397; US5504033;
US5504347; US5509771; US5556714; US5651858; US5675461; US5685684;
US5829939; US5934856; EP20246453; EP20381338; JP57-29577;
JP60-246635; JP62-44571; JP62-50463; JP62-89881; JP62-207866;
JP63-153270; JP6412037; JP636582; JP131971; JP131970; JP1135015;
JP1-251734; JP1-310553; JP1298180; JP2-61064; JP265252; JP294647;
JP2-106037; JP430549; WO8707309
R.P.H. Chang, "Multipurpose plasma reactor for materials research and processing", J. Vac. Sci. Technol., vol. 14, No. 1, Jan./Feb. 1977, pp. 278-280.

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Semiconductor Equipment Association of Japan, "Semiconductor News", vol. 4, pp. 38-43, Apr. 10, 1987 (w/translation).

STG - (B1) U.S. Patent (no pre-grant pub.) after Jan. 2, 2001
AB - This invention relates to a vacuum processing apparatus having vacuum processing chambers the insides of which must be dry cleaned, and to a method of operating such an apparatus. When the vacuum processing chambers are dry-cleaned, dummy substrates are transferred into the vacuum processing chamber by substrates conveyor means from dummy substrate storage means which is disposed in the air atmosphere together with storage means for storing substrates to be processed, and the inside of the vacuum processing chamber is dry-cleaned by generating a plasma. The dummy substrate is returned to the dummy substrate storage means after dry cleaning is completed. Accordingly, any specific mechanism for only the cleaning purpose is not necessary and the construction of the apparatus can be made simple. Furthermore, the dummy substrates used for dry cleaning and the substrates to be processed do not coexist, contamination of the substrates to be processed due to dust and remaining gas can be prevented and the production yield can be high.
UP - 2002-01

1 / 1 LGST - ©LEGSTAT
PN - US 6330755 [US6330755]
AP - US 461432/99 19991216 [1999US-0461432]
DT - US-P
ACT - 19991216 US/AE-A
APPLICATION DATA (PATENT)
US 461432/99 19991216 [1999US-0461432]

20011218 US/BA
PATENT (NO PREVIOUS PRE-GRANT PUBLICATION)

20020604 US/RF
REISSUE APPLICATION FILED
20020206
UP - 2002-24

1 / 1 CRXX - ©CLAIMS/RRX
PN - 6,330,755 A 20011218 [US6330755]
PA - Hitachi Ltd JP
ACT - 20020206 REISSUE REQUESTED
ISSUE DATE OF O.G.: 20020604
REISSUE REQUEST NUMBER: 10/066747
EXAMINATION GROUP RESPONSIBLE FOR REISSUEPROCESS: 2162

Reissue Patent Number:

1 / 1 PAST - ©Thomson Derwent

AN - 200223-001864
PN - 6330755 A [US6330755]
OG - 2002-06-04
ACT - REISSUE APPLICATION FILED

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Set	Items	Description
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S1	1	PN=US 6330755
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DIALOG(R)File 345:Inpadoc/Fam.& Legal Stat
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10473594
Basic Patent (No,Kind,Date): EP 475604 A1 19920318 <No. of Patents: 080>

PATENT FAMILY:
GERMANY (DE)

Patent (No,Kind,Date): DE 69128861 C0 19980312
VAKUUMSBEHANDLUNGSVORRICHTUNG UND REINIGUNGSVERFAHREN DAFUER (German)
Patent Assignee: HITACHI LTD (JP)
Author (Inventor): KATO SHIGEKAZU (JP); TSUBONE TSUNEHICO (JP);
NISHIHATA KOUJI (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): JP 90225321 A 19900829
Applic (No,Kind,Date): DE 69128861 A 19910819
IPC: * H01L-021/00
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: German
Patent (No,Kind,Date): DE 69128861 T2 19981008
VAKUUMSBEHANDLUNGSVORRICHTUNG UND REINIGUNGSVERFAHREN DAFUER (German)
Patent Assignee: HITACHI LTD (JP)
Author (Inventor): KATO SHIGEKAZU (JP); TSUBONE TSUNEHICO (JP);
NISHIHATA KOUJI (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): JP 90225321 A 19900829
Applic (No,Kind,Date): DE 69128861 A 19910819
IPC: * H01L-021/00
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: German

EUROPEAN PATENT OFFICE (EP)

Patent (No,Kind,Date): EP 475604 A1 19920318
VACUUM PROCESSING APPARATUS AND CLEANING METHOD THEREFOR (English;
French; German)
Patent Assignee: HITACHI LTD (JP)
Author (Inventor): KATO SHIGEKAZU (JP); TSUBONE TSUNEHICO (JP);
NISHIHATA KOUJI (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): JP 90225321 A 19900829
Applic (No,Kind,Date): EP 91307625 A 19910819
Designated States: (National) DE; FR; GB
IPC: * H01L-021/00
Derwent WPI Acc No: ; G 92-090205
Language of Document: English
Patent (No,Kind,Date): EP 805481 A2 19971105
VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English;
French; German)
Patent Assignee: HITACHI LTD (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)

Priority (No,Kind,Date): EP 91307625 A3 19910819; JP 90225321 A
 19900829
 Applic (No,Kind,Date): EP 97111628 A 19910819
 Designated States: (National) DE; FR; GB
 IPC: * H01L-021/00; C23C-014/56
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844; C 97-529274
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): EP 856875 A2 19980805
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English;
 French; German)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): EP 97111628 A3 19910819; JP 90225321 A
 19900829
 Applic (No,Kind,Date): EP 98106162 A 19910819
 Designated States: (National) DE; FR; GB
 IPC: * H01L-021/00
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844; G 98-401136
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): EP 1076354 A2 20010214
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English;
 French; German)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); TSUBONE TSUNEHICO (JP);
 NISHIHATA KOUJI (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): EP 97111628 A3 19910819; EP 91307625 A3
 19910819; JP 90225321 A 19900829
 Applic (No,Kind,Date): EP 2000121402 A 19910819
 Designated States: (National) DE; FR; GB
 IPC: * H01L-021/00
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): EP 1079418 A2 20010228
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English;
 French; German)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); TSUBONE TSUNEHICO (JP);
 NISHIHATA KOUJI (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): EP 97111628 A3 19910819; EP 91307625 A3
 19910819; JP 90225321 A 19900829
 Applic (No,Kind,Date): EP 2000121401 A 19910819
 Designated States: (National) DE; FR; GB
 IPC: * H01L-021/00
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844; G 02-107535
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): EP 805481 A3 19980520
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English;
 French; German)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): EP 91307625 A3 19910819; JP 90225321 A
 19900829

Applic (No,Kind,Date): EP 97111628 A 19910819
 Designated States: (National) DE; FR; GB
 IPC: * H01L-021/00; C23C-014/56
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): EP 856875 A3 19990428
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English; French; German)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): EP 97111628 A3 19910819; JP 90225321 A 19900829
 Applic (No,Kind,Date): EP 98106162 A 19910819
 Designated States: (National) DE; FR; GB
 IPC: * H01L-021/00
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): EP 1076354 A3 20020807
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English; French; German)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); TSUBONE TSUNEHICO (JP); NISHIHATA KOUJI (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): EP 97111628 A3 19910819; EP 91307625 A3 19910819; JP 90225321 A 19900829
 Applic (No,Kind,Date): EP 2000121402 A 19910819
 Designated States: (National) DE; FR; GB
 IPC: * H01L-021/00
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): EP 1079418 A3 20020807
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English; French; German)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); TSUBONE TSUNEHICO (JP); NISHIHATA KOUJI (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): EP 97111628 A3 19910819; EP 91307625 A3 19910819; JP 90225321 A 19900829
 Applic (No,Kind,Date): EP 2000121401 A 19910819
 Designated States: (National) DE; FR; GB
 IPC: * H01L-021/00
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): EP 475604 B1 19980204
 VACUUM PROCESSING APPARATUS AND CLEANING METHOD THEREFOR (English; French; German)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); TSUBONE TSUNEHICO (JP); NISHIHATA KOUJI (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): JP 90225321 A 19900829
 Applic (No,Kind,Date): EP 91307625 A 19910819
 Designated States: (National) DE; FR; GB
 IPC: * H01L-021/00

Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English

JAPAN (JP)

Patent (No,Kind,Date): JP 4108531 A2 19920409
VACUUM TREATMENT APPARATUS (English)
Patent Assignee: HITACHI LTD
Author (Inventor): KATO SHIGEKAZU; NISHIHATA KOJI; TSUBONE TSUNEHICO;
ITO ATSUSHI
Priority (No,Kind,Date): JP 90225321 A 19900829
Applic (No,Kind,Date): JP 90225321 A 19900829
IPC: * B01J-003/00
JAPIO Reference No: ; 160351C000155
Language of Document: Japanese
Patent (No,Kind,Date): JP 4110169 A2 19920410
IMAGE RECORDER (English)
Patent Assignee: CANON KK
Author (Inventor): SUZUKI AKIO
Priority (No,Kind,Date): JP 90228396 A 19900831
Applic (No,Kind,Date): JP 90228396 A 19900831
IPC: * B41J-002/365; B41J-002/36
JAPIO Reference No: ; 160353M000093
Language of Document: Japanese
Patent (No,Kind,Date): JP 2644912 B2 19970825
SHINKUSHORISOCHIOYOBISONONTENHOHO (English)
Priority (No,Kind,Date): JP 90225321 A 19900829
Applic (No,Kind,Date): JP 90225321 A 19900829
IPC: * B01J-003/00
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: Japanese
Patent (No,Kind,Date): JP 2950950 B2 19990920
Priority (No,Kind,Date): JP 90228396 A 19900831
Applic (No,Kind,Date): JP 90228396 A 19900831
IPC: * B41J-002/01; B41J-002/36
Derwent WPI Acc No: * G 94-279094
JAPIO Reference No: * 160353M000093
Language of Document: Japanese

KOREA, REPUBLIC (KR)

Patent (No,Kind,Date): KR 184682 B1 19990415
VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
Patent Assignee: HITACHI LTD (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): JP 90225321 A 19900829
Applic (No,Kind,Date): KR 9114984 A 19910829
IPC: * H01L-021/304
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: Korean
Patent (No,Kind,Date): KR 212819 B1 19990901
TRANSFERRING SYSTEM AND VACUUM TREATING APPARATUS AND METHOD THEREBY
(English)
Patent Assignee: HITACHI LTD (JP)
Author (Inventor): NISHIHATA GOJI (JP); TSUBONE TSUNEHICO (JP); ITO
ATSUSHI (JP)
Priority (No,Kind,Date): JP 90225321 A 19900829; KR 9114984 A3

19910829

Applic (No,Kind,Date): KR 9846757 A 19981102

IPC: * H01L-021/304

Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G 02-107535; G 02-123844

JAPIO Reference No: * 160351C000155

Language of Document: Korean

Patent (No,Kind,Date): KR 212874 B1 19990901

TRANSFERRING SYSTEM AND VACUUM TREATING APPARATUS THEREBY (English)

Patent Assignee: HITACHI LTD (JP)

Author (Inventor): GATO SIGEGATSU (JP); NISHIHATA GOJI (JP); TSUBONE TSUNEHICO (JP); ITO ATSUSI (JP)

Priority (No,Kind,Date): JP 90225321 A 19900829; KR 9114984 A3 19910829

Applic (No,Kind,Date): KR 9846756 A 19981102

IPC: * H01L-021/304

Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G 02-107535; G 02-123844

JAPIO Reference No: * 160351C000155

Language of Document: Korean

UNITED STATES OF AMERICA (US)

Patent (No,Kind,Date): US 5314509 A 19940524

VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)

Patent Assignee: HITACHI LTD (JP)

Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)

Priority (No,Kind,Date): JP 90225321 A 19900829

Applic (No,Kind,Date): US 751951 A 19910829

National Class: * 034406000; 034092000; 134902000; 414225000

IPC: * B08B-003/00; C23C-016/00

Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G 02-107535; G 02-123844

JAPIO Reference No: * 160351C000155

Language of Document: English

Patent (No,Kind,Date): US 5343231 A 19940830

IMAGE RECORDING APPARATUS CAPABLE OF CORRECTING DENSITY UNEVENNESS (English)

Patent Assignee: CANON KK (JP)

Author (Inventor): SUZUKI AKIO (JP)

Priority (No,Kind,Date): US 3992 A 19930115; JP 90228396 A 19900831; US 751952 B1 19910829

Applic (No,Kind,Date): US 3992 A 19930115

National Class: * 347014000; 347015000

IPC: * B41J-002/05

Derwent WPI Acc No: * G 94-279094; G 94-279094

JAPIO Reference No: * 160353M000093

Language of Document: English

Patent (No,Kind,Date): US 5349762 A 19940927

VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)

Patent Assignee: HITACHI LTD (JP)

Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)

Priority (No,Kind,Date): US 96256 A 19930726; JP 90225321 A 19900829; US 751951 A1 19910829

Applic (No,Kind,Date): US 96256 A 19930726

National Class: * 034406000; 034092000

IPC: * F26B-005/04

Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G 02-107535; G 02-123844

JAPIO Reference No: * 160351C000155

Language of Document: English

Patent (No,Kind,Date): US 5457896 A 19951017
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 302443 A 19940909; JP 90225321 A
 19900829; US 96256 A1 19930726; US 751951 A1 19910829
 Applic (No,Kind,Date): US 302443 A 19940909
 Addnl Info: 5349762 Patented; 5314509 Patented
 National Class: * 034406000; 034092000
 IPC: * F26B-005/04
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English

Patent (No,Kind,Date): US 5553396 A 19960910
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 443039 A 19950517; JP 90225321 A
 19900829; US 302443 A3 19940909; US 96256 A1 19930726; US 751951
 A1 19910829
 Applic (No,Kind,Date): US 443039 A 19950517
 Addnl Info: 5457896 Patented; 5349762 Patented; 5314509 Patented
 National Class: * 034406000; 034092000; 414225000; 134902000
 IPC: * B08B-003/00; C23C-016/00
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English

Patent (No,Kind,Date): US 5661913 A 19970902
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 593870 A 19960130; JP 90225321 A
 19900829; US 443039 A1 19950517; US 302443 A3 19940909; US 96256
 A1 19930726; US 751951 A1 19910829
 Applic (No,Kind,Date): US 593870 A 19960130
 Addnl Info: 5553396 Patented; 5457896 Patented; 5349762 Patented;
 5314509 Patented
 National Class: * 034406000; 134902000
 IPC: * F26B-005/04
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English

Patent (No,Kind,Date): US 5784799 A 19980728
 VACUUM PROCESSING APPARATUS FOR SUBSTATE WAFERS (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 882731 A 19970626; JP 90225321 A
 19900829; US 593870 A3 19960130; US 443039 A1 19950517; US 302443
 A3 19940909; US 96256 A1 19930726; US 751951 A1 19910829
 Applic (No,Kind,Date): US 882731 A 19970626
 Addnl Info: 5661913 Patented; 5553396 Patented; 5457896 Patented;
 5349762 Patented; 5314509 Patented
 National Class: * 034092000; 414217000
 IPC: * F26B-013/30
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G

02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 5950330 A 19990914
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 61062 A 19980416; JP 90225321 A
 19900829; US 882731 A1 19970626; US 593870 A3 19960130; US 443039
 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726; US
 751951 A1 19910829
 Applic (No,Kind,Date): US 61062 A 19980416
 Addnl Info: 5784799 Patented; 5661913 Patented; 5553396 Patented;
 5457896 Patented; 5349762 Patented; 5314509 Patented
 National Class: * 034406000
 IPC: * F26B-005/04
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6012235 A 20000111
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 177495 A 19981023; JP 90225321 A
 19900829; US 61062 A1 19980416; US 882731 A1 19970626; US 593870
 A3 19960130; US 443039 A1 19950517; US 302443 A3 19940909; US
 96256 A1 19930726; US 751951 A1 19910829
 Applic (No,Kind,Date): US 177495 A 19981023
 Addnl Info: 5784799 Patented; 5661913 Patented; 5553396 Patented;
 5457896 Patented; 5349762 Patented; 5314509 Patented
 National Class: * 034406000
 IPC: * F26B-013/30
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6044576 A 20000404
 VACUUM PROCESSING AND OPERATING METHOD USING A VACUUM CHAMBER (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 390684 A 19990907; JP 90225321 A
 19900829; US 177495 A3 19981023; US 61062 A1 19980416; US 882731
 A1 19970626; US 593870 A3 19960130; US 443039 A1 19950517; US
 302443 A3 19940909; US 96256 A1 19930726; US 751951 A1 19910829
 Applic (No,Kind,Date): US 390684 A 19990907
 Addnl Info: 5950330 Patented; 5784799 Patented; 5661913 Patented;
 5553396 Patented; 5457896 Patented; 5349762 Patented; 5314509
 Patented
 National Class: * 034406000
 IPC: * F26B-005/04
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6055740 A 20000502
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);

TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 231451 A 19990115; JP 90225321 A
19900829; US 61062 A1 19980416; US 882731 A1 19970626; US 593870
A3 19960130; US 443039 A1 19950517; US 302443 A3 19940909; US
96256 A1 19930726; US 751951 A1 19910829
Applic (No,Kind,Date): US 231451 A 19990115
Addnl Info: 5784799 Patented; 5661913 Patented; 5553396 Patented;
5457896 Patented; 5349762 Patented; 5314509 Patented
National Class: * 034092000; 034228000
IPC: * F26B-013/30
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 6070341 A 20000606
VACUUM PROCESSING AND OPERATING METHOD WITH WAFERS, SUBSTRATES AND/OR
SEMICONDUCTORS (English)
Patent Assignee: HITACHI LTD (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 390681 A 19990907; JP 90225321 A
19900829; US 177495 A3 19981023; US 61062 A1 19980416; US 882731
A1 19970626; US 593870 A3 19960130; US 443039 A1 19950517; US
302443 A3 19940909; US 96256 A1 19930726; US 751951 A1 19910829
Applic (No,Kind,Date): US 390681 A 19990907
Addnl Info: 5950330 Patented; 5784799 Patented; 5661913 Patented;
5553396 Patented; 5457896 Patented; 5349762 Patented; 5314509
Patented
National Class: * 034406000
IPC: * F26B-005/04
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 6108929 A 20000829
VACUUM PROCESSING APPARATUS (English)
Patent Assignee: HITACHI LTD (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 461433 A 19991216; JP 90225321 A
19900829; US 231451 A1 19990115; US 61062 A1 19980416; US 882731
A1 19970626; US 593870 A3 19960130; US 443039 A1 19950517; US
302443 A3 19940909; US 96256 A1 19930726; US 751951 A1 19910829
Applic (No,Kind,Date): US 461433 A 19991216
Addnl Info: 5950330 Patented; 5784799 Patented; 5661913 Patented;
5553396 Patented; 5457896 Patented; 5349762 Patented; 5314509
Patented
National Class: * 034092000
IPC: * F26B-013/30
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 6112431 A 20000905
VACUUM PROCESSING AND OPERATING METHOD (English)
Patent Assignee: HITACHI LTD (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 389461 A 19990903; JP 90225321 A
19900829; US 177495 A3 19981023; US 61062 A1 19980416; US 882731
A1 19970626; US 593870 A3 19960130; US 443039 A1 19950517; US
302443 A3 19940909; US 96256 A1 19930726; US 751951 A1 19910829

Applic (No,Kind,Date): US 389461 A 19990903
Addnl Info: 5950330 Patented; 5784799 Patented; 5661913 Patented;
5553396 Patented; 5457896 Patented; 5349762 Patented; 5314509
Patented
National Class: * 034406000
IPC: * F26B-005/04
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 20010000048 AA 20010322
VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
TSUNEHICO (JP); ITOU ATSUSHI (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 725257 A 20001129; JP 90225321 A
19900829; US 552572 A1 20000419; US 461432 B3 19991216; US 177495
A1 19981023; US 61062 A1 19980416; US 882731 A1 19970626; US
593870 A3 19960130; US 443039 A1 19950517; US 302443 A3
19940909; US 96256 A1 19930726; US 751951 A1 19910829
Applic (No,Kind,Date): US 725257 A 20001129
Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
Patented; 5314509 Patented
National Class: * 034092000
IPC: * F26B-013/30
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 20010001901 AA 20010531
VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
TSUNEHICO (JP); ITOU ATSUSHI (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
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Priority (No,Kind,Date): US 766976 A 20010123; JP 90225321 A
19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
; US 751952 B1 19910829
Applic (No,Kind,Date): US 766976 A 20010123
Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
Patented
National Class: * 034406000
IPC: * F26B-005/04
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
98-401136; G 02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 20010001902 AA 20010531
VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
TSUNEHICO (JP); ITOU ATSUSHI (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 767837 A 20010124; JP 90225321 A
19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726

; US 751952 B1 19910829; US 766587 A3 20010123
Applic (No,Kind,Date): US 767837 A 20010124
Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
Patented
National Class: * 034406000
IPC: * F26B-005/04
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
98-401136; G 02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 20010002517 AA 20010607
VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
TSUNEHICO (JP); ITOU ATSUSHI (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 766975 A 20010123; JP 90225321 A
19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
; US 751952 B1 19910829
Applic (No,Kind,Date): US 766975 A 20010123
Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
Patented
National Class: * 034406000
IPC: * F26B-005/04
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
98-401136; G 02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 20010003873 AA 20010621
VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
TSUNEHICO (JP); ITOU ATSUSHI (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 781296 A 20010213; JP 90225321 A
19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
; US 751951 A1 19910829; US 766587 A 20010123
Applic (No,Kind,Date): US 781296 A 20010213
Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
Patented; 5314509 Patented
National Class: * 034406000
IPC: * F26B-005/04
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 20010004554 AA 20010621
VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
TSUNEHICO (JP); ITOU ATSUSHI (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 766587 A 20010123; JP 90225321 A
19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US

443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
; US 751952 B1 19910829
Applic (No,Kind,Date): US 766587 A 20010123
Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
Patented
National Class: * 438758000; 438907000
IPC: * H01L-021/31
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
98-401136; G 02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 20010004807 AA 20010628
VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
TSUNEHICO (JP); ITOU ATSUSHI (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 780444 A 20010212; JP 90225321 A
19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
; US 751952 B1 19910829
Applic (No,Kind,Date): US 780444 A 20010212
Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
Patented
National Class: * 034406000; 034092000
IPC: * F26B-013/30
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
98-401136; G 02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 20010007175 AA 20010712
VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
TSUNEHICO (JP); ITOU ATSUSHI (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 781298 A 20010213; JP 90225321 A
19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
; US 751952 B1 19910829
Applic (No,Kind,Date): US 781298 A 20010213
Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
Patented
National Class: * 034417000
IPC: * F26B-005/04
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
98-401136; G 02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 20010008050 AA 20010719
VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
TSUNEHICO (JP); ITOU ATSUSHI (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 781293 A 20010213; JP 90225321 A
19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062

A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751952 B1 19910829
 Applic (No,Kind,Date): US 781293 A 20010213
 Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
 5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
 Patented
 National Class: * 034406000
 IPC: * F26B-013/30
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 20010008051 AA 20010719
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
 TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 781295 A 20010213; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751952 B1 19910829
 Applic (No,Kind,Date): US 781295 A 20010213
 Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
 5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
 Patented
 National Class: * 034406000
 IPC: * F26B-013/30
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 20010008052 AA 20010719
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
 TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 781297 A 20010213; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751951 A1 19910829; US 766587 A3 20010123
 Applic (No,Kind,Date): US 781297 A 20010213
 Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
 5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
 Patented; 5314509 Patented
 National Class: * 034406000
 IPC: * F26B-013/30
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 20010009073 AA 20010726
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THERFOR (English)
 Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
 TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 766597 A 20010123; JP 90225321 A

19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
; US 751951 A1 19910829
Applic (No,Kind,Date): US 766597 A 20010123
Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
Patented; 5314509 Patented
National Class: * 034406000
IPC: * F26B-013/30; F26B-005/04
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 20010009074 AA 20010726
VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
TSUNEHICO (JP); ITOU ATSUSHI (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 781270 A 20010213; JP 90225321 A
19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
; US 751952 B1 19910829
Applic (No,Kind,Date): US 781270 A 20010213
Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
Patented
National Class: * 034406000
IPC: * F26B-013/30; F26B-005/04
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
98-401136; G 02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 20010009075 AA 20010726
VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
TSUNEHICO (JP); ITOU ATSUSHI (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 781452 A 20010213; JP 90225321 A
19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
; US 751952 B1 19910829
Applic (No,Kind,Date): US 781452 A 20010213
Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
Patented
National Class: * 034406000
IPC: * F26B-013/30; F26B-005/04
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
98-401136; G 02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 20010009076 AA 20010726
SUBSTRATE CHANGING-OVER MECHANISM IN A VACCUM TANK, COMPRISING
(English)
Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
TSUNEHICO (JP); ITOU ATSUSHI (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);

TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 782194 A 20010214; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751951 A1 19910829
 Applic (No,Kind,Date): US 782194 A 20010214
 Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
 5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
 Patented; 5314509 Patented
 National Class: * 034406000
 IPC: * F26B-013/30; F26B-005/04
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 20010010126 AA 20010802
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
 TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 782193 A 20010214; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751952 B1 19910829
 Applic (No,Kind,Date): US 782193 A 20010214
 Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
 5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
 Patented
 National Class: * 034406000
 IPC: * F26B-005/04
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 20010011422 AA 20010809
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
 TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 781317 A 20010213; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751951 A1 19910829
 Applic (No,Kind,Date): US 781317 A 20010213
 Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
 5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
 Patented; 5314509 Patented
 National Class: * 034092000
 IPC: * F26B-013/30
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 20010011423 AA 20010809
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
 TSUNEHICO (JP); ITOU ATSUSHI (JP)

Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 782197 A 20010214; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751952 B1 19910829
 Applic (No,Kind,Date): US 782197 A 20010214
 Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
 5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
 Patented
 National Class: * 034092000
 IPC: * F26B-013/30
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 20010016990 AA 20010830
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
 TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 782192 A 20010214; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751951 A1 19910829; US 766587 A3 20010123
 Applic (No,Kind,Date): US 782192 A 20010214
 Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
 5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
 Patented; 5314509 Patented
 National Class: * 034406000
 IPC: * F26B-013/30; F26B-005/04
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 20010020339 AA 20010913
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
 TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 780394 A 20010212; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751952 B1 19910829
 Applic (No,Kind,Date): US 780394 A 20010212
 Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
 5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
 Patented
 National Class: * 034406000
 IPC: * F26B-013/30; F26B-005/04
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 20010020340 AA 20010913
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE

TSUNEHIKO (JP); ITOU ATSUSHI (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHIKO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 782196 A 20010214; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751951 A1 19910829; US 766587 A3 20010123
 Applic (No,Kind,Date): US 782196 A 20010214
 Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
 5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
 Patented; 5314509 Patented
 National Class: * 034406000
 IPC: * F26B-005/04
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 20010037585 AA 20011108
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
 TSUNEHIKO (JP); ITOU ATSUSHI (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHIKO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 767834 A 20010124; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751952 B1 19910829
 Applic (No,Kind,Date): US 767834 A 20010124
 Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
 5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
 Patented
 National Class: * 034406000; 034092000
 IPC: * F26B-013/30
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 20020032972 AA 20020321
 SUBSTRATE CHANGING-OVER MECHANISM IN VACUUM TANK (English)
 Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
 TSUNEHIKO (JP); ITOU ATSUSHI (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHIKO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 782195 A 20010214; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751952 B1 19910829; US 766587 A3 20010123
 Applic (No,Kind,Date): US 782195 A 20010214
 Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
 5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
 Patented
 National Class: * 034406000
 IPC: * F26B-013/30
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6263588 BA 20010724
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)

Patent Assignee: HITACHI LTD (US)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 614770 A 20000712; JP 90225321 A
19900829; US 552572 A3 20000419; US 461432 B3 19991216; US 177495
A1 19981023; US 61062 A1 19980416; US 882731 A1 19970626; US
593870 A3 19960130; US 443039 A1 19950517; US 302443 A3
19940909; US 96256 A1 19930726; US 751951 A1 19910829
Applic (No,Kind,Date): US 614770 A 20000712
Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
Patented; 5314509 Patented
National Class: * 034417000; 034229000
IPC: * F26B-005/04
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 6301801 BA 20011016
VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
Patent Assignee: KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP); TSUBONE
TSUNEHICO (JP); ITOU ATSUSHI (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 552572 A 20000419; JP 90225321 A
19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
; US 751951 A1 19910829
Applic (No,Kind,Date): US 552572 A 20000419
Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
Patented; 5314509 Patented
National Class: * 034406000; 034092000; 034228000
IPC: * F26B-005/04
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 6301802 BA 20011016
VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
Patent Assignee: HITACHI LTD (US)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 765379 A 20010122; JP 90225321 A
19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
; US 751952 B1 19910829
Applic (No,Kind,Date): US 765379 A 20010122
Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
Patented
National Class: * 034406000; 034417000; 034092000; 034229000;
118729000; 414744100; 414744600; 414939000; 414940000
IPC: * F26B-005/04
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
98-401136; G 02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 6330755 BA 20011218
VACUUM PROCESSING AND OPERATING METHOD (English)

Patent Assignee: HITACHI LTD (US)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 461432 A 19991216; JP 90225321 A
 19900829; US 177495 A1 19981023; US 61062 A1 19980416; US 882731
 A1 19970626; US 593870 A3 19960130; US 443039 A1 19950517; US
 302443 A3 19940909; US 96256 A1 19930726; US 751951 A1 19910829
 Applic (No,Kind,Date): US 461432 A 19991216
 Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
 5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
 Patented; 5314509 Patented
 National Class: * 034406000
 IPC: * F26B-005/04
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6330756 BA 20011218
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: HITACHI LTD (US)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 614764 A 20000712; JP 90225321 A
 19900829; US 552572 A3 20000419; US 461432 B3 19991216; US 177495
 A1 19981023; US 61062 A1 19980416; US 882731 A1 19970626; US
 593870 A3 19960130; US 443039 A1 19950517; US 302443 A3
 19940909; US 96256 A1 19930726; US 751951 A1 19910829
 Applic (No,Kind,Date): US 614764 A 20000712
 Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
 5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
 Patented; 5314509 Patented
 National Class: * 034406000; 034417000
 IPC: * F26B-005/04
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6446353 BA 20020910
 VACUUM PROCESSING APPARATUS (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 781270 A 20010213; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751952 B1 19910829
 Applic (No,Kind,Date): US 781270 A 20010213
 Addnl Info: 6330755 Patented; 6012235 Patented; 5950330 Patented;
 5784799 Patented; 5661913 Patented; 5553396 Patented; 5457896
 Patented; 5349762 Patented
 National Class: * 034092000; 034060000; 034236000; 414217000;
 414222130; 414939000
 IPC: * F26B-013/30
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6463676 BA 20021015
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);

TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 780427 A 20010212; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751952 B1 19910829
 Applic (No,Kind,Date): US 780427 A 20010212
 Addnl Info: 6330755 Patented; 6012235 Patented; 5950330 Patented;
 5784799 Patented; 5661913 Patented; 5553396 Patented; 5457896
 Patented; 5349762 Patented
 National Class: * 034412000; 034092000; 034218000; 134902000;
 414217000
 IPC: * F26B-005/04
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6314658 BB 20011113
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: HITACHI LTD (US)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 725257 A 20001129; JP 90225321 A
 19900829; US 552572 A1 20000419; US 461432 B3 19991216; US 177495
 A1 19981023; US 61062 A1 19980416; US 882731 A1 19970626; US
 593870 A3 19960130; US 443039 A1 19950517; US 302443 A3
 19940909; US 96256 A1 19930726; US 751951 A1 19910829
 Applic (No,Kind,Date): US 725257 A 20001129
 Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
 5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
 Patented; 5314509 Patented
 National Class: * 034406000; 034092000; 414225000; 134902000
 IPC: * F26B-005/04; B08B-003/00
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6332280 BB 20011225
 VACUUM PROCESSING APPARATUS (English)
 Patent Assignee: HITACHI LTD (US)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 767834 A 20010124; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751952 B1 19910829
 Applic (No,Kind,Date): US 767834 A 20010124
 Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
 5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
 Patented; 5314509 Patented
 National Class: * 034217000; 034092000; 034222000; 034225000;
 034236000; 414939000; 414940000; 134902000; 156345000
 IPC: * F26B-019/00
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6339887 BB 20020122
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);

TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 767837 A 20010124; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751952 B1 19910829; US 766587 A3 20010123
 Applic (No,Kind,Date): US 767837 A 20010124
 Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
 5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
 Patented
 National Class: * 034406000; 034417000; 034092000; 034229000;
 118729000; 414744600; 414939000; 414940000
 IPC: * F26B-005/04
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6457253 BB 20021001
 VACUUM PROCESSING APPARATUS (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 781317 A 20010213; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751951 A1 19910829
 Applic (No,Kind,Date): US 781317 A 20010213
 Addnl Info: 6330755 Patented; 6012235 Patented; 5950330 Patented;
 5784799 Patented; 5661913 Patented; 5553396 Patented; 5457896
 Patented; 5349762 Patented; 5314509 Patented
 National Class: * 034092000; 414217000; 134902000
 IPC: * F26B-013/30
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6460270 BB 20021008
 VACUUM PROCESSING APPARATUS (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 780394 A 20010212; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751952 B1 19910829
 Applic (No,Kind,Date): US 780394 A 20010212
 Addnl Info: 6330755 20000801 Patented; 6012235 Patented; 5950330
 Patented; 5784799 Patented; 5661913 Patented; 5553396 Patented;
 5457896 Patented; 5349762 Patented
 National Class: * 034092000; 134902000; 414217000
 IPC: * F26B-013/30
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6463678 BB 20021015
 SUBSTRATE CHANGING-OVER MECHANISM IN A VACCUM TANK (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)

Priority (No,Kind,Date): US 782194 A 20010214; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751951 A1 19910829
 Applic (No,Kind,Date): US 782194 A 20010214
 Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
 5661973 Patented; 5553396 Patented; 5457896 Patented; 5349762
 Patented; 5314509 Patented
 National Class: * 034573000; 034526000; 034527000; 034573000;
 034209000; 034217000; 414217000; 414940000
 IPC: * F26B-013/10
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6467186 BB 20021022
 TRANSFERRING DEVICE FOR A VACUUM PROCESSING APPARATUS AND OPERATING
 METHOD THEREFOR (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 766976 A 20010123; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751952 B1 19910829
 Applic (No,Kind,Date): US 766976 A 20010123
 Addnl Info: 6330755 Patented; 6012235 Patented; 5950330 Patented;
 5784799 Patented; 5661913 Patented; 5553396 Patented; 5457896
 Patented; 5349762 Patented
 National Class: * 034092000; 043060000; 043236000; 414217000;
 414222130; 414939000
 IPC: * F26B-013/30
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6467187 BB 20021022
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 782192 A 20010214; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751951 A1 19910829; US 766587 A3 20010123
 Applic (No,Kind,Date): US 782192 A 20010214
 Addnl Info: 6330755 Patented; 6012235 Patented; 5950330 Patented;
 5784799 Patented; 5661913 Patented; 5553396 Patented; 5457896
 Patented; 5349762 Patented
 National Class: * 034092000; 034060000; 134085000; 134902000
 IPC: * F26B-013/30
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6470596 BB 20021029
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);

TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 767837 A 20010124; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751952 B1 19910829; US 766587 A3 20010123
 Applic (No,Kind,Date): US 767837 A 20010124
 Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
 5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
 Patented
 National Class: * 034406000; 034417000; 034092000; 034229000;
 118729000; 414744600; 414939000; 414940000
 IPC: * F26B-005/04
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6473989 BB 20021105
 CONVEYING SYSTEM FOR A VACUUM PROCESSING APPARATUS (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 781297 A 20010213; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751951 A1 19910829; US 766587 A3 20010123
 Applic (No,Kind,Date): US 781297 A 20010213
 Addnl Info: 6330755 Patented; 6012235 Patented; 5950330 Patented;
 5784799 Patented; 5661913 Patented; 5553396 Patented; 5457896
 Patented; 5349762 Patented
 National Class: * 034092000; 034060000; 034236000; 414217000;
 414222130; 414939000
 IPC: * F26B-013/30
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6484414 BB 20021126
 VACUUM PROCESSING APPARATUS (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 781298 A 20010213; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751952 B1 19910829
 Applic (No,Kind,Date): US 781298 A 20010213
 Addnl Info: 6330755 Patented; 6012235 Patented; 5950330 Patented;
 5784799 Patented; 5661913 Patented; 5553396 Patented; 5457896
 Patented; 5349762 Patented
 National Class: * 034092000; 034060000; 034236000; 414217000;
 414222130; 414939000
 IPC: * F26B-013/30
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6484415 BB 20021126
 VACUUM PROCESSING APPARATUS (English)
 Patent Assignee: HITACHI LTD (JP)

Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 782193 A 20010214; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751952 B1 19910829
 Applic (No,Kind,Date): US 782193 A 20010214
 Addnl Info: 6330755 Patented; 6012235 Patented; 5950330 Patented;
 5784799 Patented; 5661913 Patented; 5553396 Patented; 5457896
 Patented; 5349762 Patented
 National Class: * 034092000; 034060000; 034236000; 414222130;
 414217000
 IPC: * F26B-013/30
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6487791 BB 20021203
 VACUUM PROCESSING APPARATUS (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 782196 A 20010214; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751951 A1 19910829; US 766587 A3 20010123
 Applic (No,Kind,Date): US 782196 A 20010214
 Addnl Info: 6330755 Patented; 6012235 Patented; 5950330 Patented;
 5784799 Patented; 5661913 Patented; 5553396 Patented; 5457896
 Patented; 5349762 Patented
 National Class: * 034217000; 034092000; 034222000; 034225000;
 034236000; 134902000; 414939000; 414940000; 156345000
 IPC: * F26B-019/00
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 98-401136; G
 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6487793 BB 20021203
 VACUUM PROCESSING APPARATUS AND OPERATING METHOD THEREFOR (English)
 Patent Assignee: HITACHI LTD (JP)
 Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
 TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
 Priority (No,Kind,Date): US 766587 A 20010123; JP 90225321 A
 19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
 A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
 443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
 ; US 751952 B1 19910829
 Applic (No,Kind,Date): US 766587 A 20010123
 Addnl Info: 6330755 Patented; 6012235 Patented; 5950330 Patented;
 5784799 Patented; 5661913 Patented; 5553396 Patented; 5457896
 Patented; 5349762 Patented
 National Class: * 034412000; 034406000; 034418000; 034500000;
 034092000; 034218000; 134902000; 414939000; 414222130
 IPC: * F26B-005/04
 Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
 98-401136; G 02-107535; G 02-123844
 JAPIO Reference No: * 160351C000155
 Language of Document: English
 Patent (No,Kind,Date): US 6487794 BB 20021203
 SUBSTRATE CHANGING-OVER MECHANISM IN VACUUM TANK (English)

Patent Assignee: HITACHI LTD (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 782195 A 20010214; JP 90225321 A
19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
; US 751952 B1 19910829; US 766587 A3 20010123
Applic (No,Kind,Date): US 782195 A 20010214
Addnl Info: 6330755 Patented; 6012235 Patented; 5950330 Patented;
5784799 Patented; 5661913 Patented; 5553396 Patented; 5457896
Patented; 5349762 Patented
National Class: * 034573000; 034526000; 034527000; 034209000;
034217000; 414217000; 414939000; 414940000
IPC: * F26B-013/10
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
98-401136; G 02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 6490810 BB 20021210
VACUUM PROCESSING APPARATUS (English)
Patent Assignee: HITACHI LTD (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 782197 A 20010214; JP 90225321 A
19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
; US 751952 B1 19910829
Applic (No,Kind,Date): US 782197 A 20010214
Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
Patented
National Class: * 034092000; 414225000; 134902000
IPC: * F26B-013/30
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
98-401136; G 02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English
Patent (No,Kind,Date): US 6499229 BB 20021231
VACUUM PROCESSING APPARATUS (English)
Patent Assignee: HITACHI LTD (JP)
Author (Inventor): KATO SHIGEKAZU (JP); NISHIHATA KOUJI (JP);
TSUBONE TSUNEHICO (JP); ITOU ATSUSHI (JP)
Priority (No,Kind,Date): US 781293 A 20010213; JP 90225321 A
19900829; US 461432 A3 19991216; US 177495 A1 19981023; US 61062
A1 19980416; US 882731 A1 19970626; US 593870 A3 19960130; US
443039 A1 19950517; US 302443 A3 19940909; US 96256 A1 19930726
; US 751952 B1 19910829
Applic (No,Kind,Date): US 781293 A 20010213
Addnl Info: 6012235 Patented; 5950330 Patented; 5784799 Patented;
5661913 Patented; 5553396 Patented; 5457896 Patented; 5349762
Patented
National Class: * 034217000; 034092000; 034222000; 034225000;
034236000; 414939000; 414940000; 134902000; 156345000
IPC: * F26B-019/00
Derwent WPI Acc No: * C 97-529274; G 92-090205; G 94-279094; G
98-401136; G 02-107535; G 02-123844
JAPIO Reference No: * 160351C000155
Language of Document: English